

TLBGA1100(T11), TLRPA1100(T11)

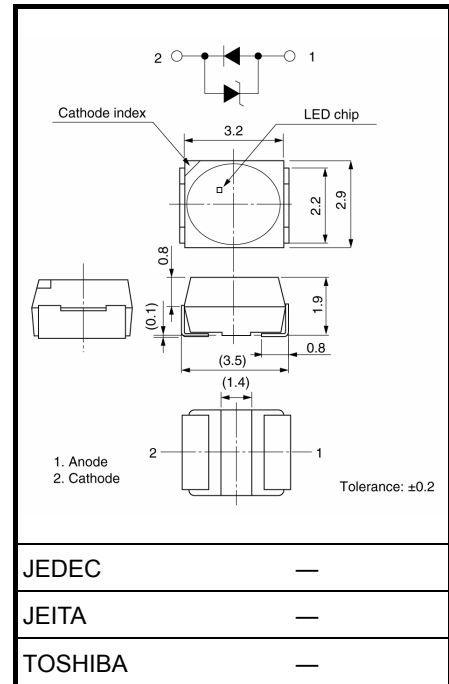
Unit: mm

Panel Circuit Indicator

- Surface-mount devices
- 3.2 (L) × 2.9 (W) × 1.9 (H) mm
- UV LED chip + RGB phosphor
- Colors: bluish green, reddish purple
- Topr / Tstg = -40 to 100°C
- Reflow soldering is possible
- Applications: automotive use,
backlighting, etc.
- Standard embossed tape packing: T11 (2000/reel)
8-mm tape reel

Color and Material

Product Name	Color	Material
TLBGA1100	Bluish Green	GaN
TLRPA1100	Reddish Purple	GaN



Weight: 0.035 g (typ.)

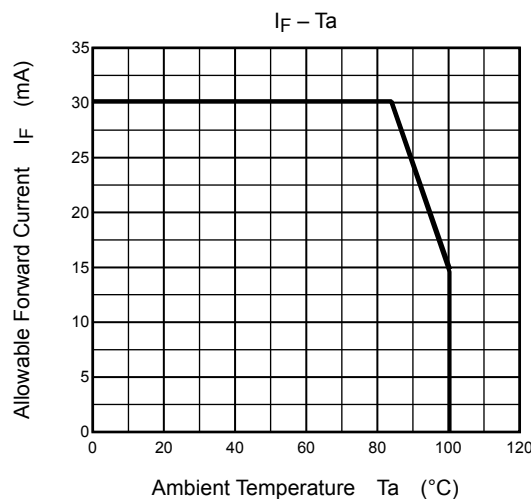
Absolute Maximum Ratings (Ta = 25°C)

Product Name	Forward Current IF (mA) Please see Note 1	Power Dissipation PD (mW)	Operation Temperature Topr (°C)	Storage Temperature Tstg (°C)
TLBGA1100	30	126	-40~100	-40~100
TLRPA1100				

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Forward current derating



Electrical Characteristics (Ta = 25°C)

Product Name	Forward Voltage V _F				Reverse Current V _R			
	Min	Typ.	Max	I _F	Min	Typ.	Max	I _R
TLBGA1100	—	3.5	4.2	20	—	0.75	—	10
TLRPA1100	—	3.5	4.2		—	0.75	—	
Unit	V			mA	V			mA

Optical Characteristics–1 (Ta = 25°C)

Product Name	Luminous Intensity I _v				Available I _v rank (Note 2)
	Min	Typ.	Max	I _F	
TLBGA1100	63	100	320	20	QA / RA / SA
TLRPA1100	40	70	200	20	PA / QA / RA
Unit	mcd			mA	

Note 2: The specification as following table is used for I_v classification of LEDs in Toshiba facility.
Each reel includes the same rank LEDs. Let the delivery ratio of each rank be unquestioned.

I _v rank		
Rank symbol	Min	Max
PA	40	80
QA	63	125
RA	100	200
SA	160	320
Unit	mcd	mcd

Optical Characteristics–2 (Ta = 25°C)

Product Name	Chromaticity x C _x			Chromaticity y C _y			
	Min	Typ.	Max	Min	Typ.	Max	I _F
TLBGA1100	—	0.15	—	—	0.32	—	20mA
TLRPA1100	—	0.35	—	—	0.20	—	

Note 3: Ultraviolet light luminescence

These LED lamps also emit some UV light. (Around 360~400nm)

When these LED lamps are used for general indicator, it is no problem. However the LEDs are not recommended for the following applications.

(1) Prohibition

- Human eye is damaged by the condensed light. (Ex. microscope, outer lens, etc)

(2) Notice

- LEDs are located at near a skin (the distance is less than 20mm), and exposure time is more than 60 min.

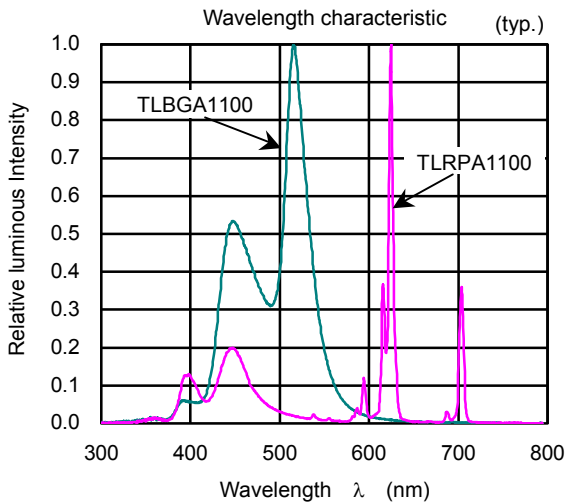
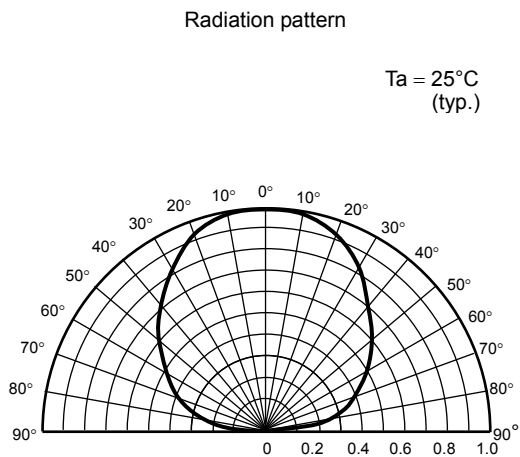
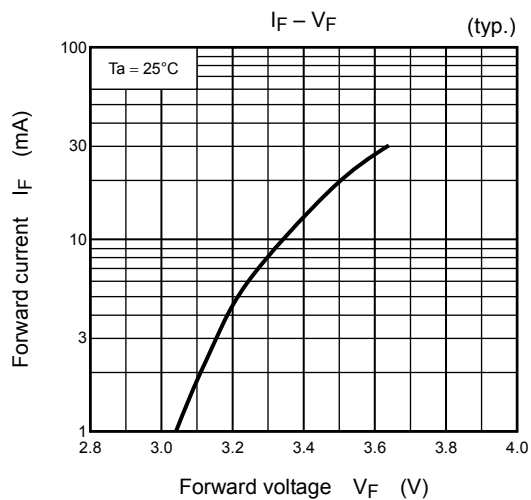
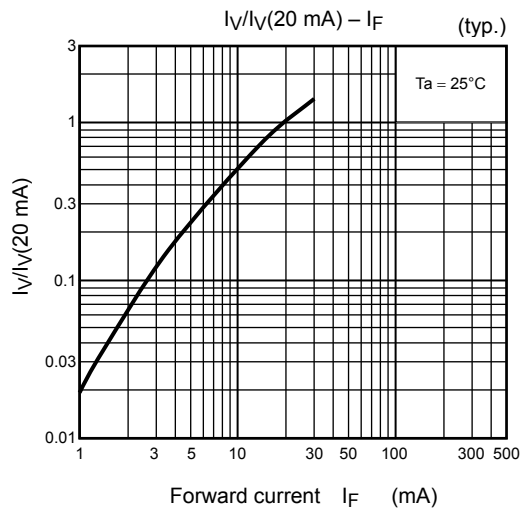
- Photosensitive material is used with these LEDs in a set. It might be damaged by the light.

Note 4: Do not break, cut or pulverize the products.

Note 5: This product is designed as a general display light source usage, and it has applied the measurement standard that matched with the sensitivity of human's eyes. Therefore, it is not intended for usage of functional application (ex. Light source for sensor, optical communication and etc) except general display light source.

TLBGA1100,TLRPA1100

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Packaging

These LED devices are packed in an aluminum envelope with silica gel and a moisture indicator to prevent moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

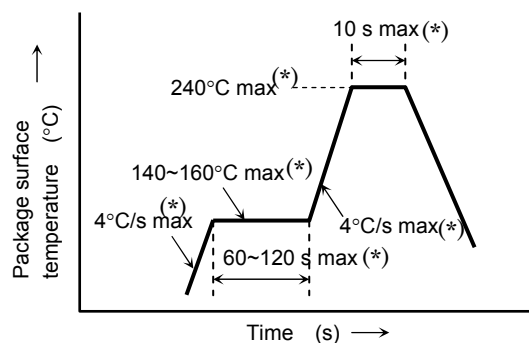
1. This moisture proof bag may be stored unopened for up to 12 months under the following conditions.
Temperature: 5°C~30°C
Humidity: 90% (max)
2. After the moisture proof bag has been opened, the devices should be assembled within 168 hours in an environment of 5°C to 30°C/60% RH or below.
3. If, upon opening, the moisture indicator card shows humidity of 30% or above (when the indication color changes to pink) or the expiration date has passed, the devices should be baked while packed in the tape reel. After baking, use the baked devices within 72 hours, but perform baking only once.
Baking conditions: 60±5°C, for 12 to 24 hours.
Expiration date: 12 months from sealing date, which is imprinted on the same side as this label affixed.
4. Repeated baking may cause the peeling strength of the tape to change, leading to trouble in mounting. Also, be sure to prevent damage to the device from static electricity during the baking process.
5. Any breakage in the laminate packing material will cause the hermeticity of the product to deteriorate. Do not toss or drop the packed devices.

Mounting Method

Soldering

- Reflow soldering

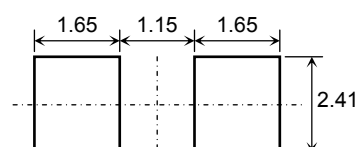
Temperature profile (example)



- The products are evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (*)MAX values) as a evaluation. Please perform reflow soldering under the above conditions.
- Please perform the first reflow soldering with reference to the above temperature profile and within 168 h of opening the package.
- Second reflow soldering
In case of second reflow soldering should be performed within 168 h of the first reflow under the above conditions.
Storage conditions before the second reflow soldering: 30°C, 60% RH (max)
- Make any necessary soldering corrections manually.
(only once at each soldering point)
Soldering iron : 25 W
Temperature : 300°C or less
Time : within 3 s
- If the product needs to be performed by other soldering method (ex. wave soldering), please contact Toshiba sales representative.

Recommended soldering pattern

Unit: mm



Cleaning

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When cleaning is required after soldering, Toshiba recommends the following cleaning solvents.
It is confirmed that these solvents have no effect on semiconductor devices in our dipping test (under the recommended conditions). In selecting the one for your actual usage, please perform sufficient review on washing condition, using condition and etc.

ASAHI CLEAN AK-225AES	: (made by ASAHI GLASS)
KAO CLEAN TROUGH 750H	: (made by KAO)
PINE ALPHA ST-100S	: (made by ARAKAWA CHEMICAL)
TOSHIBA TECHNOCARE (FRW-17, FRW-1, FRV-100)	: (made by GE TOSHIBA SILICONES)

Precautions when Mounting

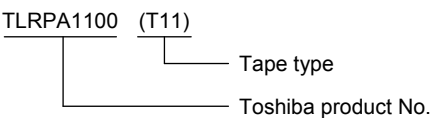
Do not apply force to the plastic part of the LED under high-temperature conditions.
To avoid damaging the LED plastic, do not apply friction using a hard material.
When installing the PCB in a product, ensure that the device does not come into contact with other components.

Tape Specifications

1. Product number format

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (This method, however, does not apply to products whose electrical characteristics differ from standard Toshiba specifications.)

- (1) Tape Type: T11 (4-mm pitch)
- (2) Example

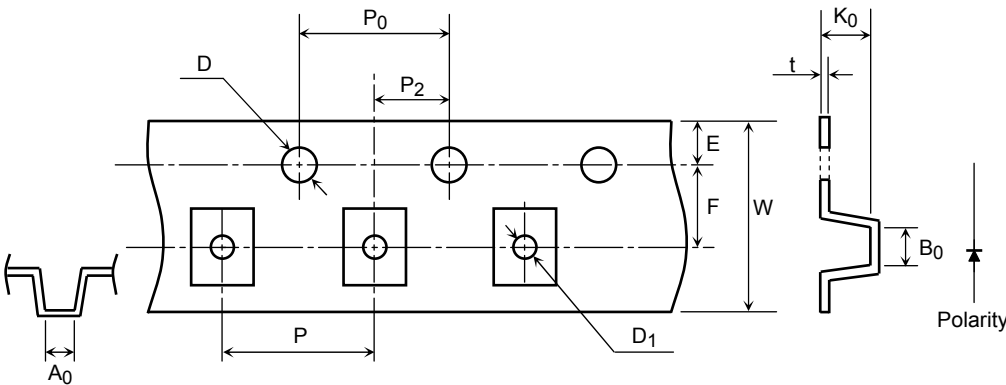


2. Tape dimensions

Unit: mm

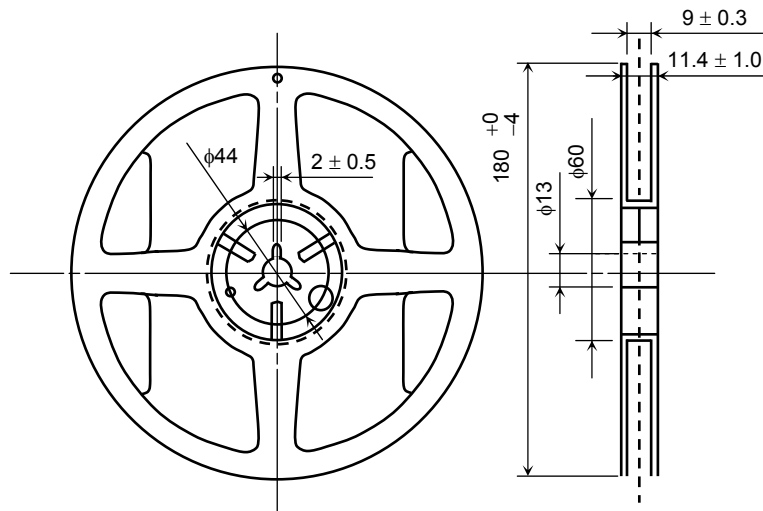
Symbol	Dimension	Tolerance
D	1.5	+0.1/-0
E	1.75	±0.1
P ₀	4.0	±0.1
t	0.3	±0.05
F	3.5	±0.05
D ₁	1.5	±0.1

Symbol	Dimension	Tolerance
P ₂	2.0	±0.05
W	8.0	±0.3
P	4.0	±0.1
A ₀	2.9	±0.1
B ₀	3.7	±0.1
K ₀	2.3	±0.1

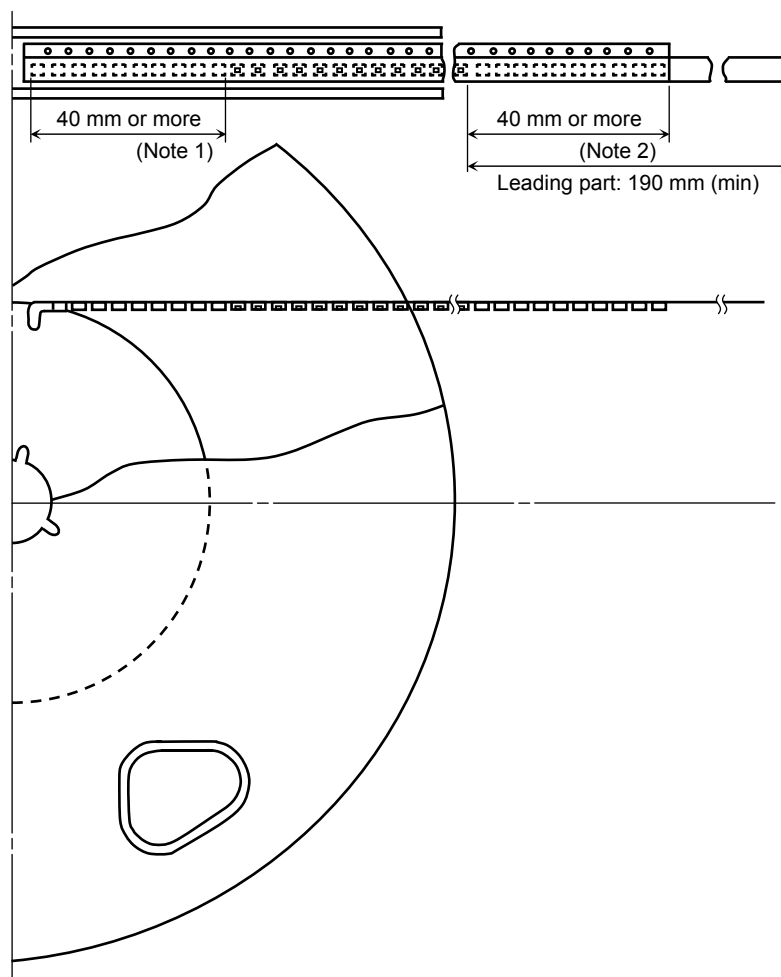


3. Reel dimensions

Unit: mm



4. Leader and trailer sections of tape



Note1: Empty trailer section

Note2: Empty leader section

RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
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